Chengming(Steven) Li

Summary Portfolio: https://stevenlcm16.wixsite.com/chengmingli-steven

stevenlcm16@gmail.com | 650-304-9670 **GitHub:** https://github.com/stevenli518

Detail-oriented team player seeking an internship, starting from 03/2025, or a full-time role, starting from 06-07/2025, in Electrical Engineering, RF, or IC-related positions to apply and expand technical skills

Fast Learner

Managed to use the internet and online references to study Cadence Virtuoso in less than 2 weeks.

• Hardware Skills

Component Selection, PCB design, Oscilloscope, Function Generator, Digital Multimeter, Spectrum Analyzer, Surface Mount Soldering Programming Languages

Python, C/C++, C#, Verilog/System Verilog, MATLAB, Tcl, HTML&CSS, SQL

Software Skills

Altium, LTspice, Cadence Virtuoso, allegro, Quartus, ModelSim, Simplicity Studio, VSCode, Visual Studio, MS Office, GitHub, Confluence, Lattice, Slack

Relevant Coursework: Communication Circuit Design, Power Amplifier Design, Analog IC Design, VLSI, Universal Verification Methodology, Modern Communication Networks, Embedded System, Computer Organization, RTOS,

Planning to Take: CMOS Analog Integrated Circuits & Systems, Power Electronics, PMIC

Work/Research Experience

Renesas Electronics America Inc

San Jose, CA

Hardware Engineer Intern

June 2024 - Sep 2024

- Analyzed induction cooktop circuits, focusing on component selection, datasheets, power consumption, and circuit protection
- Simulated induction cooktop(IH) in LTspice, Flux, and Altium, and tested LC tank, gate driver, and OVP using Oscilloscope
- Compared 8-layer Allegro Gerber files with Altium designs and summarized differences in electrical and non-electrical layers

Eridan Communications

Sunnyvale, CA

RF Test Engineer Intern

June 2023 - Aug 2023

- Built a MATLAB and C# DLL-to-Python conversion framework on GitHub for 7+ instruments and PCB testing
- Developed and executed batch scripts to semi-auto the installation process (under 5 minutes) of VScode, Python, and Rclone

University of Colorado at Boulder (Dr. Taylor Barton's RF Power and Analog Lab)

Boulder, CO

Research Assistant

Aug 2022 - May 2023

- Implemented multi-digital filters using Vivado FPGA (Red Pitaya) to reduce the distortion in the Class-AB power amplifier
- Automated the test with RF Generator, Spectrum Analyzer, and Power Supply to collect the IMD3, Pout, and Current data
- Processed the IMD3 data using Python and characterized the optimal transfer function using the network analyzer

Project Experience (for more info and pics: https://stevenlcm16.wixsite.com/chengmingli-steven/projects)

9-bit SAR ADC Tape out, PCB Design and Automated Test

San Diego, CA

Member of group 2

April 2024 - Dec 2024

- Laid out comparator, capacitive DAC, non-overlapping clock generator and switches, and digital logic using cadence virtuoso
- Used Common centroid and Dummy device to minimize input offset (90u V) and propagation delay(323.6p s) of comparator
- Designed the schematic and layout of the mother and daughter board in Altium, considering the test and debug configurability

Scalable Electrosurgical Unit for Controlling and Powering the Ligasure Dissection Device

Boulder, CO Aug 2022 - May 2023

- Software Lead (Sponsor: Medtronic)
 - Created ADC, PWM, SCI, and CLA modules in C on the TI TMS320F28004C board in response to firmware development
- Reduced the RMS values calculation from 25% to 1.7% errors by using the bitwise mask to optimize the instruction cycles

4 Layer Instrument Droid PCB Design

Boulder, CO

Individual

Nov 2022 - Dec2022

- Developed 4 Layer PCB used to measure the output impedance of any voltage source lower than 12 V in Altium Designer
- Assembled the PCB's components using the Surface Mount Technology and debugged the communication issue of I2C pins

Golden Arduino PCB Design

Boulder, CO Oct 2022 - Oct 2022

- Developed the schematic and layout for the Atmega328p chip Arduino with ADC, SPI, and UART-USB features in AD
- Reduced switching and crosstalk noise by placing decoupling capacitors, continuous ground plane, and unshared return paths

Education

Individual

University of California San Diego

San Diego, CA

Master of Science in Electrical and Computer Engineering

Cumulative GPA: 3.63/4.00

University of Colorado at Boulder

Graduation Time: July 2025

Bachelor of Science in Electrical & Computer Engineering | Minor in Computer Science

Boulder, CO May 2023

Cumulative GPA: 3.81/4.00 | Honor: Dean's List (Spring 2019 – Spring 2023) | TA experience: Introduction to circuits